



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

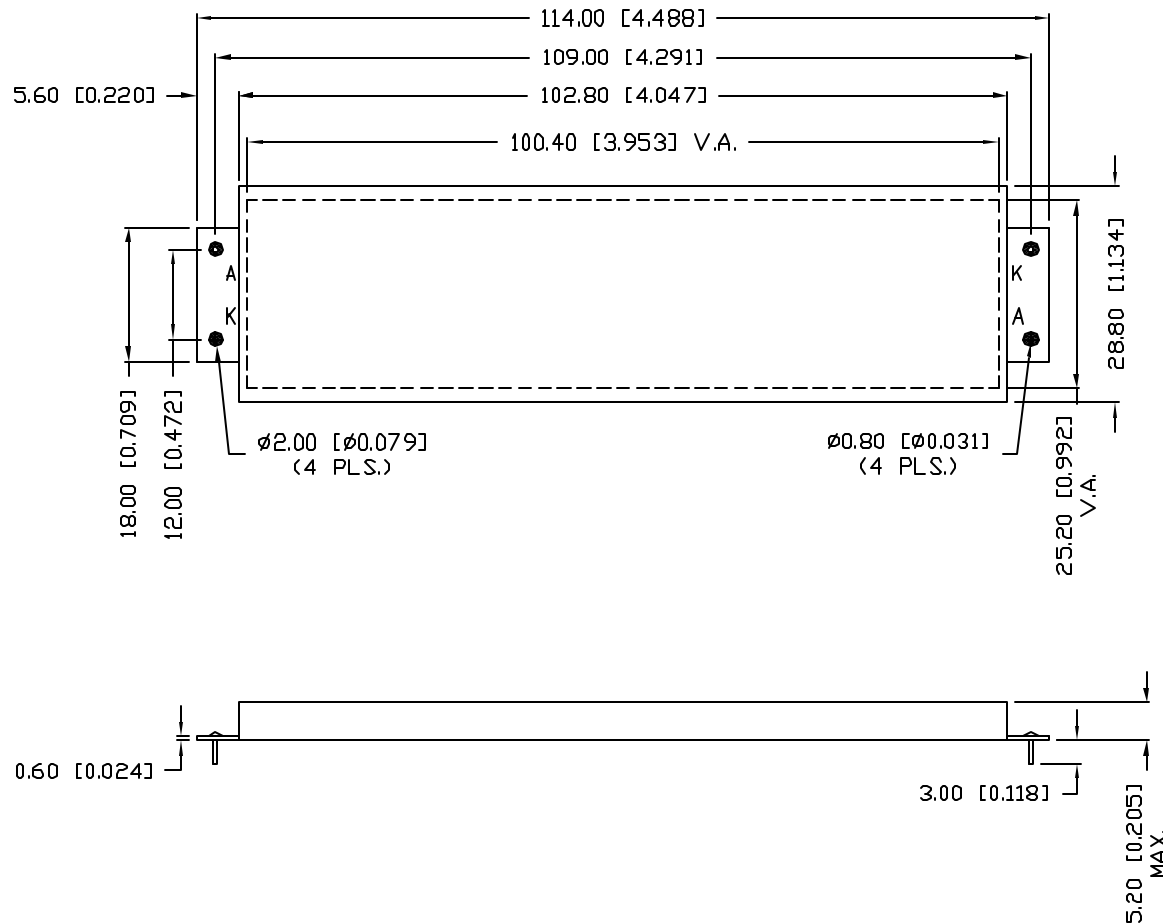
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



UNCONTROLLED DOCUMENT

PART NUMBER  
SSB-COB10025GW

REV.

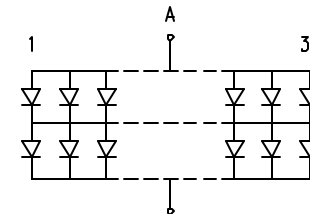


ELECTRO-OPTICAL CHARACTERISTICS  $T_A=25^{\circ}\text{C}$  PER MODULE  $I_f=360\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		565		nm	
FORWARD VOLTAGE		4.2	4.5	V <sub>f</sub>	
REVERSE VOLTAGE	8			V <sub>r</sub>	I <sub>r</sub> =3.6mA
LUMINOUS INTENSITY		250		cd/m <sup>2</sup>	I <sub>f</sub> =360mA
EMITTED COLOR:	GREEN				
REFLECTOR FINISH:	WHITE				

LIMITS OF SAFE OPERATION AT 25°C PER MODULE

PARAMETER	MAX	UNITS
STEADY CURRENT	576	mA
POWER DISSIPATION	2.59	W
DERATE FROM 25°C PER DIE	-1.2	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	°C
SOLDERING TEMP.	+260	°C
2.0mm FROM BODY		3 SEC. MAX



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\*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= +DECIMAL PRECISION -0.00 MAX= +0.00 -DECIMAL PRECISION

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100mm x 25mm VIEW AREA, CHIP ON BOARD LED BACKLIGHT,  
72 CHIPS, 565nm GREEN, 4.2V @ 360mA

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RELIABILITY NOTE

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



290 E. HELEN ROAD  
PALATINE, IL 60067-6976  
PHONE: +1.847.359.2790  
US WEB: www.lumex.com  
TW WEB: www.lumex.com.tw

DRAWN BY:

CHECKED BY:

APPROVED BY:

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BC

PAGE: 1 OF 1

SCALE: N/A